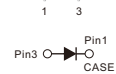


FEATURES

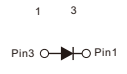
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Ultrafast Recovery Characteristics
- Low forward voltage drop
- Low Reverse Leakage Current
- Soft Recovery Characteristics
- High temperature soldering guaranteed:260°C/10 seconds,
- 0.25"(6.35mm)from case
- Component in accordance to RoHS 2015/863/EU



TO-220AC

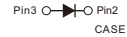
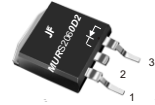


ITO-220AC



TO-263

MURS2060D2



MECHANICAL DATA

- Case: JEDEC TO-220AC ITO-220AC TO-263 molded plastic body
- Terminals: Lead solderable per MIL-STD-750,method 2026
- Polarity: As marked
- Mounting Position: Any

TYPICAL APPLICATIONS

- Anti-Parallel Diode
 - Switching Power Supply
 - Inverters
- Free wheeling Diode
 - Motor Controller
 - Converters
 - Inverters
- PFC
- Snubber,Clamp diode

PRIMARY CHARACTERISTICS

$I_F(AV)$	20.0A
V_R	600V
I_{FSM}	150A
V_f at $I_f=20.0A,125^\circ C$	1.60V
T_{rr} typ	24ns
T_{JMAX}	175°C
Diode variation	Single die

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	600	V
Maximum average forward rectified current	$I_F(AV)$	20.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated T_J)	I_{FSM}	150	A
Operating junction temperature range	T_J	-55 to +175	°C
Storage temperature range	T_{STG}	-55 to +175	°C

ELECTRICAL CHARACTERISTICS (T_J=25°C Unless otherwise noted)

Parameter	Test Conditions		Symbol	Min.	Typ.	Max.	Unit
Breakdown voltage Blocking voltage	I _R =200μA		V _{BR} V _R	600	-	-	V
Instaneous forward voltage	T _J =25°C	I _F =1.0A	V _F ¹⁾	-	1.10	-	V
		I _F =5.0A		-	1.70	-	
		I _F =20.0A		-	2.02	2.50	
	T _J =125°C	I _F =1.0A		-	0.65	-	
		I _F =5.0A		-	1.00	-	
		I _F =20.0A		-	1.60	-	
Reverse current	T _J =25°C	V _R =600V	I _R ²⁾	-	2.0	10	μA
	T _J =100°C			-	30	150	μA
	T _J =125°C			-	100	500	
Junction capacitance	4V,1MHz		C _J	-	75	-	pF

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle

2.Pulse test: pulse width≤40ms

DYNAMIC RECOVERY CHARACTERISTICS (T_J=25°C Unless otherwise noted)

Parameter	Test Conditions		Symbol	Min.	Typ.	Max.	Unit
Reverse recovery time	I _F =0.5A,I _R =1.0A,I _{rr} =0.25A		t _{rr}	-	24	30	ns
	T _J =25°C	I _F =7.5A di/dt=200A/μS V _R =400V		-	38	-	
	T _J =125°C			-	57	-	
Peak recovery current	T _J =25°C	I _F =7.5A di/dt=200A/μS V _R =400V	I _{RRM}	-	2.8	-	A
	T _J =125°C			-	4.6	-	
Reverse recovery charge	T _J =25°C	I _F =7.5A di/dt=200A/μS V _R =400V	Q _{rr}	-	50	-	nC
	T _J =125°C			-	105	-	

THERMAL CHARACTERISTICS

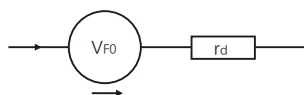
Parameter	Symbol	TO-220AC/TO-263	ITO-220AC	Unit
Typical thermal resistance ³⁾	R θ jc	2.5	4.5	°C/W

3. Thermal resistance from junction to case

AVAILABLE PACK INFORMATION

Product code	Pack	Carton Size L×W×H(mm)	Inner Box Size L×W×H(mm)	Tube Length (mm)	Inner Box Number	Tube Number Per A Inner Box	Part Number Per A Tube	Quantity(carton) (K)
MURS2060-TO-220AC	Tube	565×225×170	548×151×37	540	5	20	50	5
MURFS2060-ITO-220AC	Tube	565×225×170	548×151×37	540	5	20	50	5
MURS2060D2-TO-263	Tube	565×225×170	548×151×37	538	5	20	50	5
Product code	Pack	Carton Size L×W×H(mm)	Inner Box Size L×W×H(mm)	Reel Diameter (mm)	Inner Box Number	Reel Number Per A Inner Box	Part Number Per A Reel	Quantity(carton) (K)
MURS2060D2-TO-263	Reel	364×364×235	330×330×38	φ330	5	1	800	4

Equivalent circuits for power loss calculation



V_{fo}: threshold voltage 1.15V
 r_d: Dynamic resistance 0.06Ω
 Forward power loss of diode = V_{fo} × I_{F(AV)} + r_d × I_{F(RMS)}²

FIG.1-FORWARD CURRENT DERATING CURVE

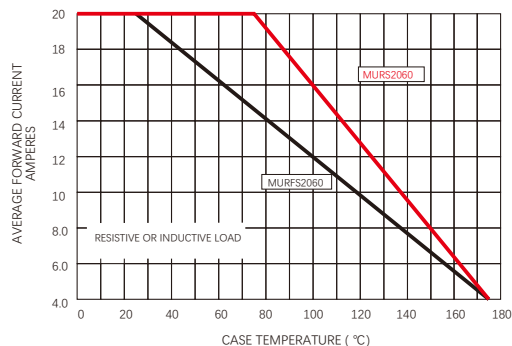


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

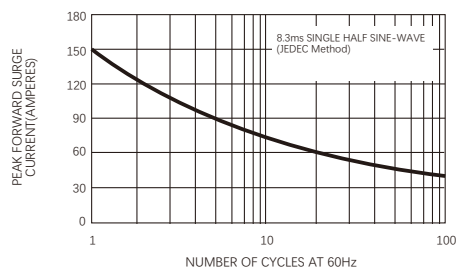


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

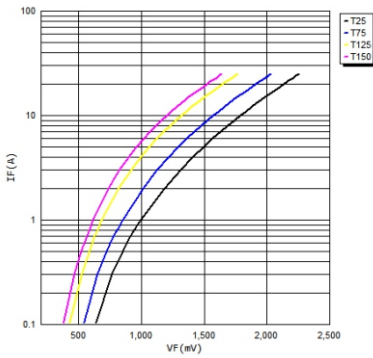


FIG.4-TYPICAL REVERSE CHARACTERISTICS

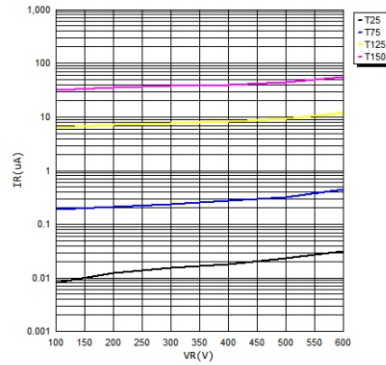


FIG.5-TYPICAL JUNCTION CAPACITANCE

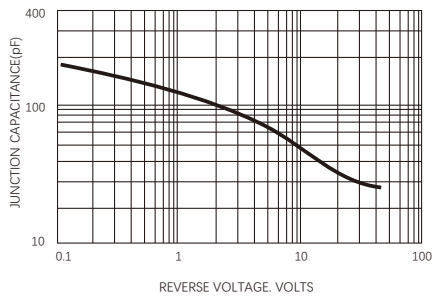


FIG.6- TYPICAL t_{rr}, t_a, t_b vs. FORWARD CURRENT

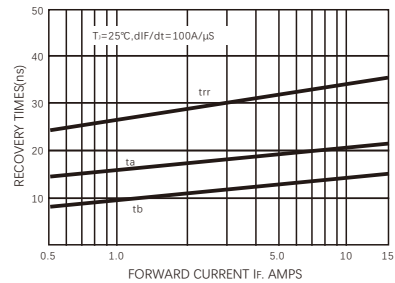
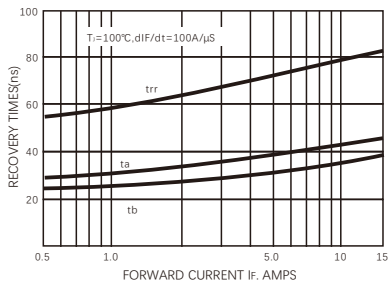
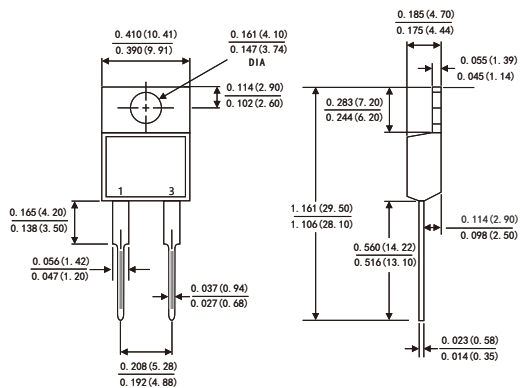


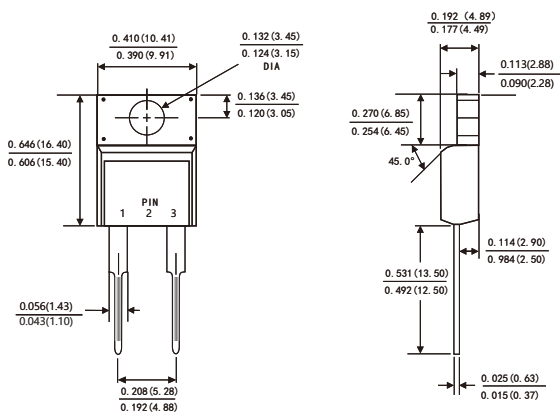
FIG.7- TYPICAL t_{rr}, t_a, t_b vs. FORWARD CURRENT



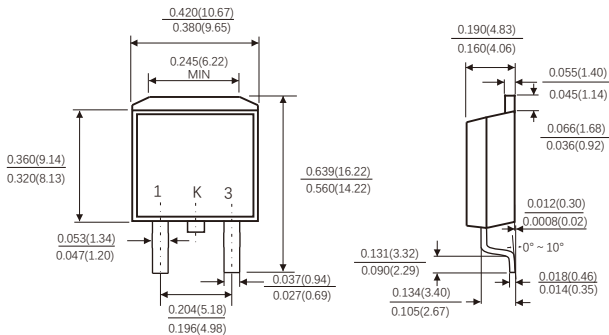
TO-220AC



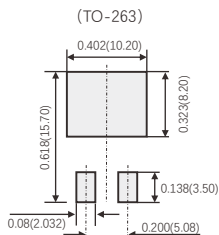
ITO-220AC



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Suggested Pad Layout



(设计者可参考推荐值根据焊接工艺要求自行确定适合的焊盘尺寸)
(Designers can refer to the recommended values according to the manufacturing process requirements to determine the appropriate pad size)

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